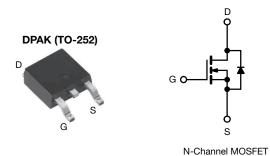
Vishay Siliconix

COMPLIANT

HALOGEN

FREE

D Series Power MOSFET



PRODUCT SUMMARY			
V _{DS} (V) at T _J max.	550		
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 \text{ V}$	3.2	
Q _g max. (nC)	12		
Q _{gs} (nC)	2		
Q _{gd} (nC)	3		
Configuration	Single		

FEATURES

- Optimal design
 - Low area specific on-resistance
 - Low input capacitance (Ciss)
 - Reduced capacitive switching losses
 - High body diode ruggedness
 - Avalanche energy rated (UIS)
- Optimal efficiency and operation
 - Low cost
 - Simple gate drive circuitry
 - Low figure-of-merit (FOM): Ron x Qa
 - Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Consumer electronics
 - Displays (LCD or plasma TV)
- Server and telecom power supplies
 - SMPS
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- · Battery chargers

ORDERING INFORMATION			
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)
Load (Db) free and balagen free	SiHD3N50D-GE3	SiHD3N50DT1-GE3	SiHD3N50DT4-GE3
Lead (Pb)-free and halogen-free	SiHD3N50DT5-GE3	SiHD3N50D-BE3	-
Lead (Pb)-free	SiHD3N50D-E3	-	-

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	500	
Gate-source voltage		V	± 30	V
Gate-source voltage AC (f > 1 Hz)		V_{GS}	30	
Continuous drain surrent (T. – 150 °C)	V_{GS} at 10 V $T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$	1_	3.0	
Continuous drain current (T _J = 150 °C)	$T_C = 100 ^{\circ}C$	Ι _D	1.9	Α
Pulsed drain current ^a		I _{DM}	5.5	
Linear derating factor			0.56	W/°C
Single pulse avalanche energy b		E _{AS}	10.4	mJ
Maximum power dissipation		P _D	69	W
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	T _J = 125 °C	dV/dt	24	V/ns
Reverse diode dV/dt ^d		u v/dt	0.22	V/IIS
Soldering recommendations (peak temperature) ^c	For 10 s		300	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 2.3 mH, R_q = 25 Ω , I_{AS} = 3 A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, starting $T_J = 25$ °C



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W
Maximum junction-to-case (drain)	R_{thJC}	-	1.8	C/VV

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				•	•	•	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		500	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.56	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	3	-	5	V
Gate-source leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 100	nA
Zero gate voltage drain current	l	V _{DS} =	= 500 V, V _{GS} = 0 V	-	-	1	μА
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 400 \text{ V}$	$V_{\rm r}, V_{\rm GS} = 0 \rm V, T_{\rm J} = 125 ^{\circ} \rm C$	-	-	10	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 1.5 A	-	2.6	3.2	Ω
Forward transconductance a	9fs	V_{DS}	$= 8 \text{ V}, I_D = 1.5 \text{ A}$	-	1	-	S
Dynamic							
Input capacitance	C_{iss}		$V_{GS} = 0 V$	-	175	-	
Output capacitance	C _{oss}		$V_{DS} = 100 \text{ V},$	-	21	-	
Reverse transfer capacitance	C_{rss}		f = 1 MHz	-	5	-	
Effective output capacitance, energy related ^b	$C_{o(er)}$	V _{DS} = 0 V to 400 V, V _{GS} = 0 V		-	21	-	pF
Effective output capacitance, time related ^c	C _{o(tr)}			-	26	-	
Total gate charge	Qg			-	6	12	
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 1.5 \text{ A}, V_{DS} = 400 \text{ V}$		-	2	-	nC
Gate-drain charge	Q _{gd}				3	-	
Turn-on delay time	t _{d(on)}	$V_{DD} = 400 \text{ V}, I_{D} = 1.5 \text{ A}$ $R_{g} = 9.1 \Omega, V_{GS} = 10 \text{ V}$		-	12	24	
Rise time	t _r			-	9	18	200
Turn-off delay time	t _{d(off)}			-	11	22	ns
Fall time	t _f			-	13	26	
Gate input resistance	R_g	f = 1 MHz, open drain		-	3.3	-	Ω
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse P - N junction diode		-	-	3	
Pulsed diode forward current	I _{SM}			-	-	12	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 1.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	T _J = 25 °C, I _F = I _S = 1.5 A, dl/dt = 100 A/ μ s, V _R = 20 V		-	293	-	ns
Reverse recovery charge	Q _{rr}			-	0.74	-	μC
Reverse recovery current	I _{RRM}			-	5	-	Α

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} c. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

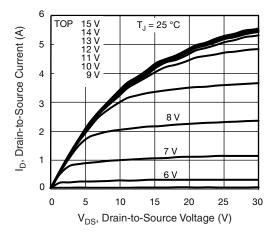


Fig. 1 - Typical Output Characteristics

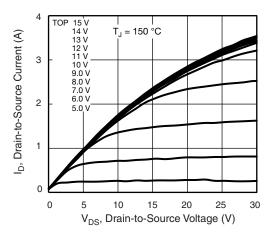


Fig. 2 - Typical Output Characteristics

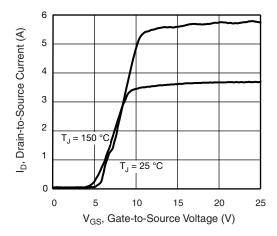


Fig. 3 - Typical Transfer Characteristics

S21-0373-Rev. F, 19-Apr-2021

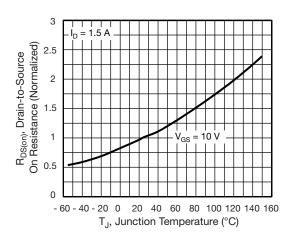


Fig. 4 - Normalized On-Resistance vs. Temperature

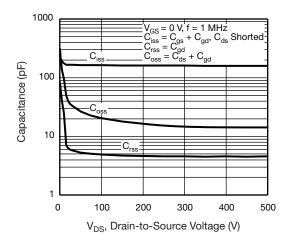


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

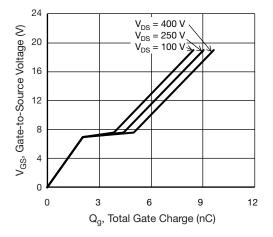


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



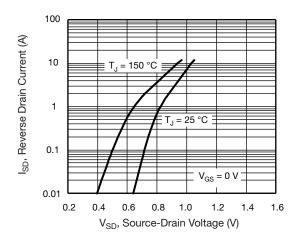


Fig. 7 - Typical Source-Drain Diode Forward Voltage

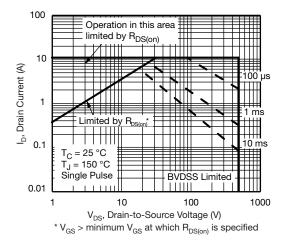


Fig. 8 - Maximum Safe Operating Area

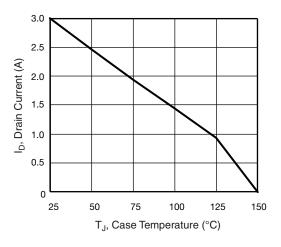


Fig. 9 - Maximum Drain Current vs. Case Temperature

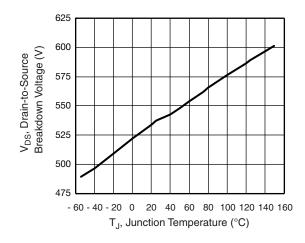


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature

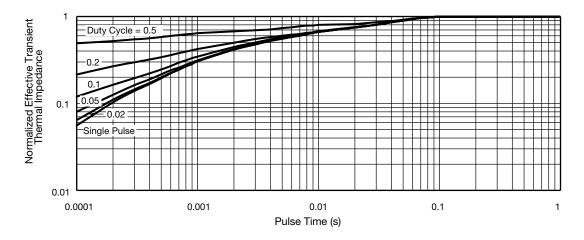


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



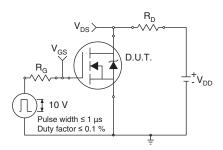


Fig. 12 - Switching Time Test Circuit

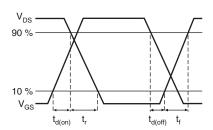


Fig. 13 - Switching Time Waveforms

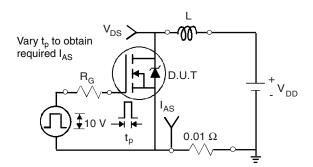


Fig. 14 - Unclamped Inductive Test Circuit

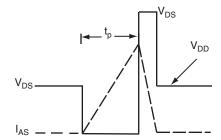


Fig. 15 - Unclamped Inductive Waveforms

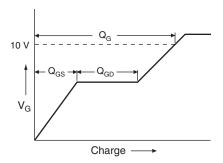


Fig. 16 - Basic Gate Charge Waveform

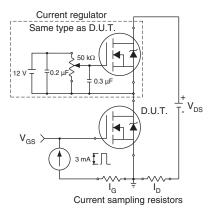
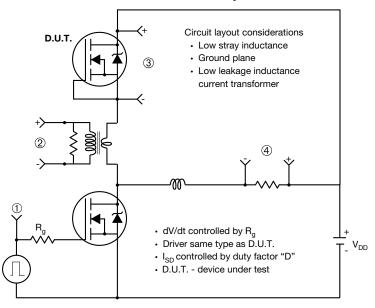


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



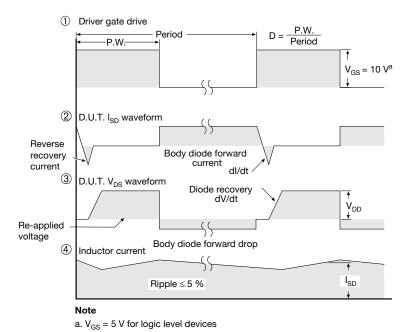


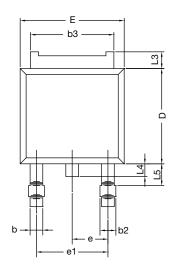
Fig. 18 - For N-Channel

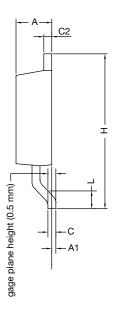
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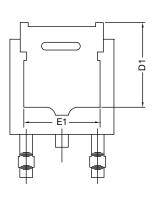


TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







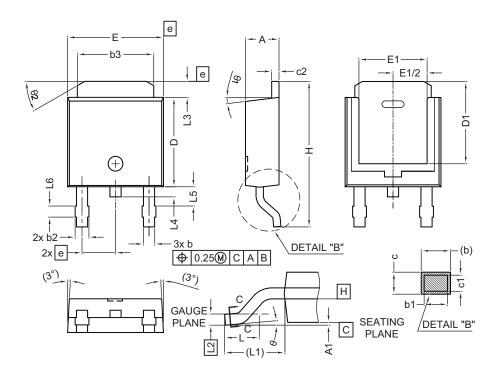
	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
Е	6.35	6.73	
E1	4.32	=	
Н	9.40	10.41	
е	2.28 BSC		
e1	4.56 BSC		
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

Note

• Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
Α	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
Е	6.35	6.73	
E1	4.32	-	
е	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	ref.	
L2	0.51	BSC	
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

Notes

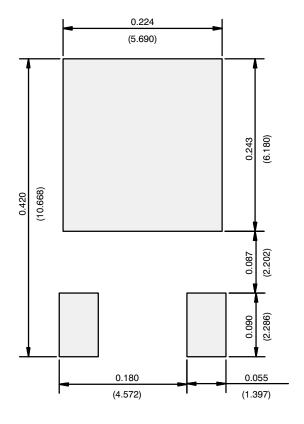
- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- · Radius on terminal is optional

ECN: E19-0649-Rev. Q, 16-Dec-2019

DWG: 5347



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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